

Customer Information Notification

Issue Date: 13-Jun-2016 Effective Date: 18-Jul-2016

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

2016060041



Change Category

[] Wafer Fab	[] Assembly	[] Product Marking	[] Test	[] Design
Process	Process		Process	
[] Wafer Fab	[X] Assembly	[] Mechanical Specification	[]Test	[] Errata
Materials	Materials		Equipment	
[] Wafer Fab	[] Assembly	[]	[] Test	[] Electrical spec./Test
Location	Location	Packing/Shipping/Labeling	Location	coverage

Additional Leadframe and Clip Frame supplier for SOT669.

Information Notification

NXP will release Enomoto as an alternative vendor for the supply of SOT669 Leadframes and Clipframes. The design is identical and the material remains unchanged.

Why do we issue this Information Notification

To ensure supply security by releasing a second source for these components.

Identification of Affected Products

Product identification does not change

Impact

None. No impact on form, fit or function, and reliability, as proven by no failures during NXP's internal qualification.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

N/A

Remarks

Enomoto have been a strategic supplier to NXP since 2011, supplying Leadframes and Clipframes for SOT1289 and SOD123W.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality

Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: Name powermos.pcn@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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